TRANSMITTAL

Electronic Version v1.1

Stylesheet Version v1.1.0

Title of Invention	METHOD OF FABRICATING A SEMICONDUCTOR DEVICE
Application Number :	
Date :	
First Named Applicar	t: Jui-Tsen Huang
Confirmation Number	:
Attorney Docket Num	ber: NAUP0487USA1

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Submitted By:	Elec. Sign.
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Registered Number: 41,526	

De como esta la ciura contractita de	Files
Documents being submitted:	Files
us request	NAUD0497 1 ugrogu yml
us-request	NAUP0487-1-usrequ.xml us-request.dtd
	us-request.xsl
us-fee-sheet	NAUP0487-1-usfees.xml
u5-166-511661	us-fee-sheet.xsl
	us-fee-sheet.dtd
us-declaration	NAUP0487-1ASS1.tif
application-body	NAUP0487-1-trans.xml
application-body	us-application-body.xsl
	application-body.dtd
	wipo.ent
	mathml2.dtd
	mathml2-qname-1.mod
	isoamsa.ent
	isoamsb.ent
	isoamsc.ent
	isoamsn.ent
	isoamso.ent
	isoamsr.ent
	isogrk3.ent
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	isomscr.ent
	isotech.ent
	isobox.ent
	isocyr1.ent
	isocyr2.ent
	isodia.ent
	isolat1.ent
	isolat2.ent
	isonum.ent
	isopub.ent
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	mmlalias.ent
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	Naup0487usa1-02.TIF
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	Naup0487usa1-04d.TIF
	Naup0487usa1-04e.TIF
	Naup0487usa1-04f.TIF
	Naup0487usa1-05.TIF
us-declaration	NAUP0487-1DEC1.tif
us-declaration	NAUP0487-1DEC2.tif
Comments	